

RoHS

COMPLIANT HALOGEN

FREE

N-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	Q _g (Typ.)				
	0.028 at V _{GS} = 4.5 V	6 ^a				
20	0.042 at V _{GS} = 2.5 V	6 ^a	8.8 nC			
	0.050 at V _{GS} = 1.8 V	5.6				



- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET
- 100 % $\rm R_g$ Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- DC/DC Converters
- Load Switch for Portable Applications

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage Gate-Source Voltage		V _{DS}	20 ± 12	V
		V _{GS}		
	T _C = 25 °C		6 ^a	
Continuous Drain Current (T 150 °C)	T _C = 70 °C		5.1	
Continuous Drain Current ($T_J = 150 \ ^{\circ}C$)	T _A = 25 °C	I _D	5 ^{b, c}	
	T _A = 70 °C		4 ^{b, c}	A
Pulsed Drain Current		I _{DM}	20	
Quality of the Design Divide Quarter	T _C = 25 °C		1.75	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	1.04 ^{b, c}	
	T _C = 25 °C		2.1	
Maximum Dawar Dissinction	T _C = 70 °C		1.3	w
Maximum Power Dissipation	T _A = 25 °C	P _D	1.25 ^{b, c}	vv
	T _A = 70 °C		0.8 ^{b, c}	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	<u></u>
Soldering Recommendations (Peak Tempera		260		

THERMAL RESISTANCE RATINGS								
Parameter		Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^{b, d}	t ≤ 5 s	R _{thJA}	80	100	°C/W			
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	40	60	- C/W			

Notes:

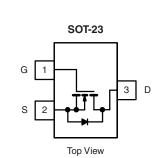
a. Package limited

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under steady state conditions is 125 $^{\circ}\text{C/W}.$

e. Based on T_C = 25 °C.



SPECIFICATIONS $T_J = 25 \text{ °C}$, unless otherwise noted								
Symbol	Test Conditions	Min.	Тур.	Max.	Unit			
V _{DS}	V_{GS} = 0 V, I_D = 250 μ A	20			V			
$\Delta V_{DS}/T_{J}$	I 250 uA		25		mV/°C			
$\Delta V_{GS(th)}/T_J$	η - 200 μλ		- 2.6					
V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	0.45		1.0	V			
I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 8 V$			± 100	nA			
1	$V_{DS} = 20 V, V_{GS} = 0 V$	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$		1				
DSS	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 ^{\circ}\text{C}$			10	μA			
I _{D(on)}	$V_{DS}{\leq}5$ V, $V_{GS}{=}4.5$ V	20			A			
	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 5.0 \text{ A}$		0.028					
R _{DS(on)}	$V_{GS} = 2.5 \text{ V}, I_D = 4.7 \text{ A}$		0.042		Ω			
	$V_{GS} = 1.8 \text{ V}, \text{ I}_{D} = 4.3 \text{ A}$		0.050					
9 _{fs}	$V_{DS} = 10 \text{ V}, I_{D} = 5.0 \text{ A}$		24		S			
		<u>I</u>	1	1	1			
C _{iss}			865		pF			
	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz		105					
			55					
	$V_{DS} = 10 \text{ V}, V_{GS} = 5 \text{ V}, I_{D} = 5.0 \text{ A}$		12	18	nC			
Qg			8.8	14				
Q _{gs}	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 5.0 \text{ A}$		1.1					
Q _{gd}			0.7					
R _q	f = 1 MHz	0.5	2.4	4.8	Ω			
t _{d(on)}			8	16				
	V_{DD} = 10 V, R_L = 2.2 Ω		17	26	ns			
+	$\text{I}_\text{D}\cong \text{4}$ A, V_GEN = 4.5 V, R_g = 1 Ω		31	47				
t _f			8	16				
t _{d(on)}			5	10				
	V_{DD} = 10 V, R_L = 2.2 Ω		13	20				
	$I_{D}\cong$ 4 A, V_{GEN} = 5 V, R_{g} = 1 Ω		21	32				
			6	12				
Fall Time tf 6 12 Drain-Source Body Diode Characteristics								
ا _S	T _C = 25 °C			1.75				
I _{SM}				20	A			
V _{SD}	$I_{S} = 4 A, V_{GS} = 0 V$		0.75	1.2	V			
t _{rr}			12	20	ns			
			5	10	nC			
t _a	ι _F = 4 A, dl/dt = 100 A/μs, T _J = 25 °C		7					
	t _b				ns			
	$\begin{tabular}{ c c c } \hline Symbol \\ \hline \hline V_{DS} \\ \hline $\Delta V_{DS} / T_J$ \\ \hline $\Delta V_{GS} (th) / T_J$ \\ \hline $\Delta V_{GS} (th) / T_J$ \\ \hline $\Delta V_{GS} (th) / T_J$ \\ \hline $V_{GS} (th) \\ \hline I_{GSS} \\ \hline I_{DSS} \\ \hline C_{rss} \\ \hline$	$\begin{tabular}{ c c c c } \hline Symbol & Test Conditions \\ \hline V_{DS} & V_{GS} = 0 \ V, \ I_D = 250 \ \mu A \\ \hline \Delta V_{DS}/T_J & I_D = 250 \ \mu A \\ \hline \Delta V_{GS(th)}/T_J & V_{DS} = V_{GS}, \ I_D = 250 \ \mu A \\ \hline V_{GS(th)} & V_{DS} = 0 \ V, \ V_{GS} = 48 \ V \\ \hline V_{DS} = 20 \ V, \ V_{GS} = 0 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 20 \ V, \ V_{GS} = 0 \ V, \ V_{GS} = 0 \ V, \ V_{DS} = 20 \ V, \ V_{GS} = 0 \ V, \ V_{DS} = 20 \ V, \ V_{GS} = 0 \ V, \ V_{DS} = 20 \ V, \ V_{GS} = 0 \ V, \ V_{DS} = 20 \ V, \ V_{GS} = 0 \ V, \ V_{DS} = 20 \ V, \ V_{GS} = 0 \ V, \ V_{DS} = 20 \ V, \ V_{GS} = 0 \ V, \ U_{DS} = 20 \ V, \ V_{GS} = 0 \ V, \ U_{DS} = 20 \ V, \ V_{GS} = 0 \ V, \ U_{DS} = 20 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 5.0 \ A \\ \hline V_{DS} = 10 \ V, \ V_{SS} = 10 \ V, \ I_D = 5.0 \ A \\ \hline \hline V_{DS} = 10 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz \\ \hline \hline C_{rss} & V_{DS} = 10 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz \\ \hline \hline C_{rss} & V_{DS} = 10 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 5.0 \ A \\ \hline \hline Q_{gd} & V_{DS} = 10 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 5.0 \ A \\ \hline \hline Q_{gd} & V_{DS} = 10 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 5.0 \ A \\ \hline \hline Q_{gd} & V_{DS} = 10 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 5.0 \ A \\ \hline \hline Q_{gd} & V_{DS} = 10 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 5.0 \ A \\ \hline \hline Q_{gd} & I_D \ \equiv 4 \ A, \ V_{GEN} = 4.5 \ V, \ I_D = 10 \ A \\ \hline \hline U_D \ \equiv 4 \ A, \ V_{GEN} = 4.5 \ V, \ I_D = 10 \ A \\ \hline \hline U_D \ \equiv 4 \ A, \ V_{GEN} = 5 \ V, \ R_g = 1 \ \Omega \\ \hline \hline U_D \ \equiv 4 \ A, \ V_{GEN} = 5 \ V, \ R_g = 1 \ \Omega \\ \hline \hline V_{SD} \ I_S \ = 4 \ A, \ V_{GEN} = 5 \ V, \ R_g = 1 \ \Omega \\ \hline \hline V_{SD} \ I_S \ = 4 \ A, \ V_{GS} = 0 \ V \\ \hline \hline I_T \ H_E \ = 4 \ A, \ U_{GS} = 0 \ V \\ \hline \hline V_{SD} \ I_S \ = 4 \ A, \ V_{GS} = 0 \ V \\ \hline \hline \ V_{SD} \ I_S \ = 4 \ A, \ U_{GS} = 0 \ V \\ \hline \hline \ V_{SD} \ I_S \ = 4 \ A, \ U_{GS} = 0 \ V \\ \hline \hline \ V_{SD} \ I_S \ = 4 \ A, \ U_{GS} = 0 \ V \\ \hline \hline \ V_{SD} \ I_S \ = 4 \ A, \ U_{GS} = 0 \ V \\ \hline \hline \ V_{SD} \ I_S \ = 4 \ A, \ U_{GS} = 0 \ V \\ \hline \hline \ \ V_{SD} \ I_S \ = 4 \ A, \ U_{GS} = 0 \ V \\ \hline \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \$	$\begin{tabular}{ c c c c } \hline Symbol & Test Conditions & Min. \\ \hline V_{DS} & V_{GS} = 0 V, I_D = 250 \ \mu A & 20 \\ \hline \Delta V_{DS}/T_J & I_D = 250 \ \mu A & 0.45 \\ \hline I_D = 250 \ \mu A & 0.45 \\ \hline V_{GS(th)} & V_{DS} = V_{GS} \ I_D = 250 \ \mu A & 0.45 \\ \hline I_{GSS} & V_{DS} = 0 V, V_{GS} = \pm 8 \ V & V_{DS} = 20 \ V, V_{GS} = 0 \ V & V_{DS} = 20 \ V, V_{GS} = 0 \ V & V_{DS} = 20 \ V, V_{GS} = 0 \ V & V_{DS} = 20 \ V, V_{GS} = 0 \ V & V_{DS} = 20 \ V, V_{GS} = 0 \ V & V_{DS} = 20 \ V, V_{GS} = 0 \ V & V_{DS} = 20 \ V, V_{GS} = 0 \ V & V_{DS} = 20 \ V, V_{GS} = 0 \ V & V_{DS} = 20 \ V, V_{GS} = 0 \ V & V_{DS} = 20 \ V, V_{GS} = 0 \ V & V_{DS} = 20 \ V, V_{GS} = 0 \ V & V_{DS} = 20 \ V, V_{GS} = 0 \ V & V_{DS} = 20 \ V & V_{DS} = 10 \ V & V_{DS} = 10 \ V & V_{DS} = 10 \ V & V_{DS} = 5 \ V & I_D = 5.0 \ A \ \hline \\ \hline \hline$	$\begin{tabular}{ c c c c c } \hline Symbol & Test Conditions & Min. Typ. \\ \hline V_{DS} & V_{GS} = 0 V, I_D = 250 \ \mu A & 20 & 25 \\ \hline \Delta V_{GS}(th) & I_D = 250 \ \mu A & 0.45 & -2.6 \\ \hline V_{GS}(th) & V_{DS} = V_{GS}, I_D = 250 \ \mu A & 0.45 & -2.6 \\ \hline V_{GS}(th) & V_{DS} = 0 V, V_{GS} = 4 V & 0.45 & -2.6 \\ \hline V_{GS}(th) & V_{DS} = 20 V, V_{GS} = 0 V & -2.6 & -2.6 \\ \hline V_{DS} & V_{DS} = 20 V, V_{GS} = 0 V & -2.6 & -2.6 & -2.6 \\ \hline V_{DS} & V_{DS} = 20 V, V_{GS} = 0 V & -2.6 &$	$\begin{tabular}{ c c c c c c } \hline Symbol & Test Conditions & Min. Typ. Max. \\ \hline V_{DS} & V_{GS} = 0 \ V, \ I_D = 250 \ \mu A & 20 & 25 & 25 & 25 & 25 & 25 & 25 & 25$			

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 % b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

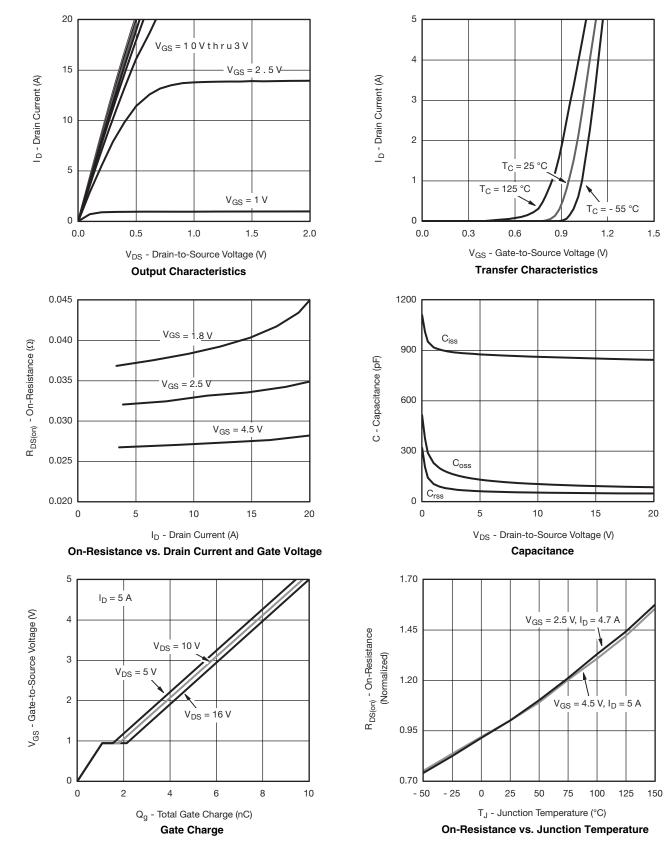
emi



1.5

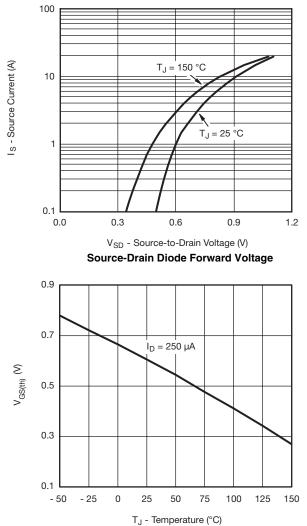
20

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

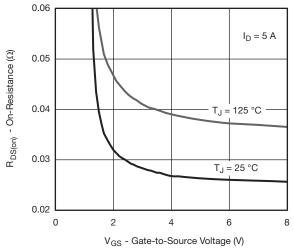




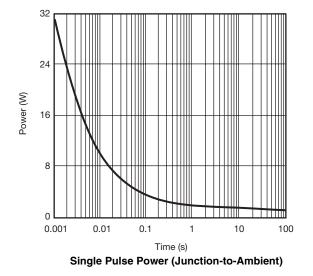
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

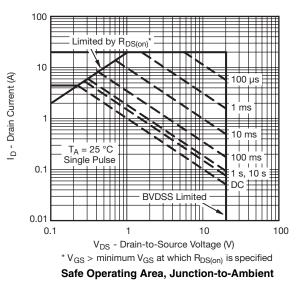


Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage

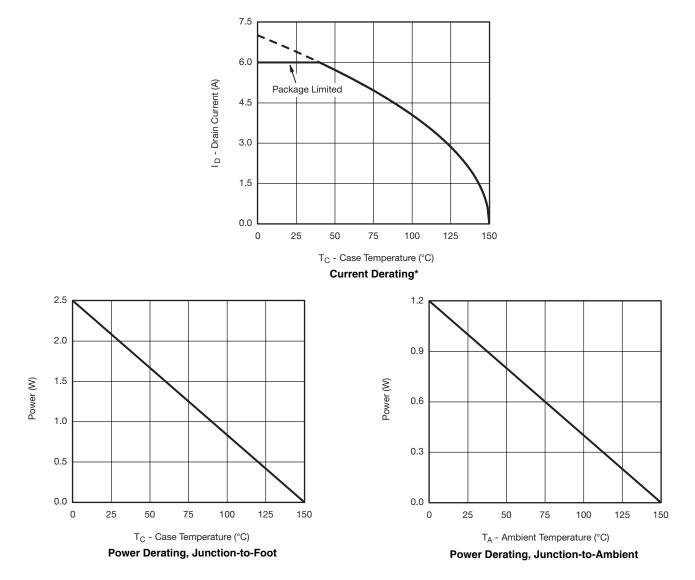




4



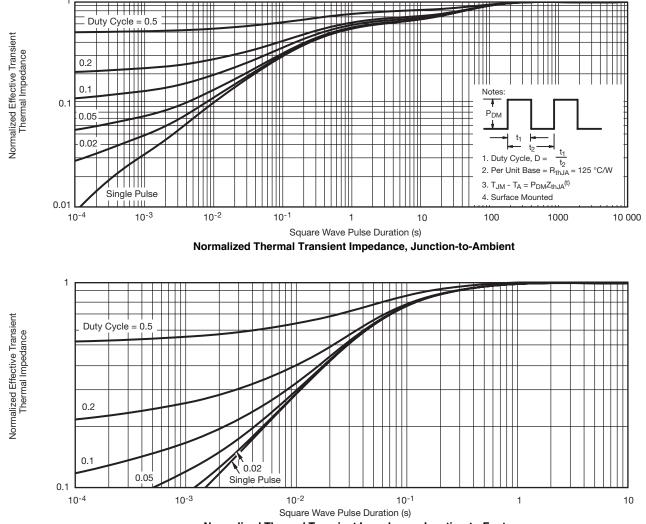
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



* The power dissipation P_D is based on $T_{J(max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

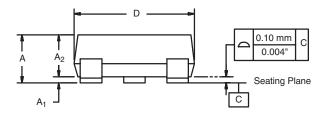


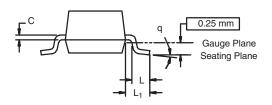




SOT-23 (TO-236): 3-LEAD



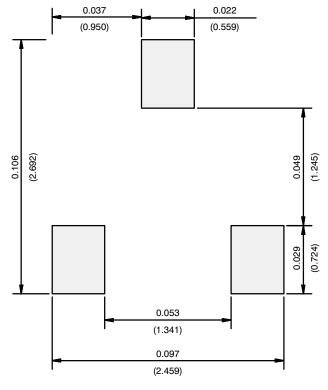




Dim	MILLI	METERS	INCHES		
	Min	Max	Min	Max	
Α	0.89	1.12	0.035	0.044	
A ₁	0.01	0.10	0.0004	0.004	
A ₂	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
C	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E ₁	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e ₁	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L ₁	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	
ECN: S-03946-Rev. K, 09- DWG: 5479	Jul-01		· · ·		



RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)



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